

1 Role of Defects in Ion Transport in Block Copolymer Electrolytes

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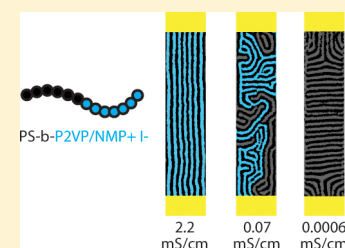
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9 **S** Supporting Information

10 **ABSTRACT:** Ion conducting block copolymers can overcome traditional limitations of
11 homopolymer electrolytes by phase separating into nanoarchitectures that can be
12 simultaneously optimized for two or more orthogonal material properties such as high ion
13 conductivity and mechanical stability. A key challenge in understanding ion transport
14 properties of these materials is the difficulty of extracting structure–function relationships
15 without having complete knowledge of all nanoscale transport pathways in bulk samples.
16 Here we demonstrate a method for deriving structure–transport relationships for ion
17 conducting block copolymers using thin films and interdigitated electrodes. Well-defined and
18 directly imaged structure in films of poly(styrene)-*block*-poly(2-vinylpyridine) is controlled
19 using techniques of directed self-assembly then the poly(2-vinylpyridine) is selectively converted into an ion conductor. The ion
20 conductivity is found to be directly proportional to the total number of connected paths between electrodes and the path length.
21 A single defect such as a dislocation anywhere in the path of an ion conducting route disconnects and precludes that pathway
22 from contributing to the conductivity and results in an increase in the dielectric parameter of the film. When all the ion
23 conduction pathways are blocked between electrodes, the conductivity is negligible, 4 orders of magnitude lower compared to a
24 completely connected morphology and the dielectric parameter increases by a factor of 50. These results have profound
25 implications for the interpretation, design, and processing of block copolymer electrolytes for applications as ion conducting
26 membranes.

27 **KEYWORDS:** Block copolymer electrolytes, thin film, ion transport, directed assembly



28 **I**on conducting polymer membranes play a central role in the
29 development of safer and more efficient electrochemical
30 devices such as fuel cells,¹ electrolyzers,² and redox flow
31 batteries.^{3–8} Membranes composed of a single component
32 often suffer from trade-offs between high ionic conductivity
33 and mechanical robustness.⁹ Block copolymer electrolytes
34 (BCEs) are promising candidates as membrane materials
35 because of the opportunity to simultaneously optimize two (or
36 more) orthogonal properties.^{10,11} The two components of a
37 diblock BCE, for example, can be optimized for both ion
38 conductivity and mechanical properties. The blocks can then
39 self-assemble into a structure of nanoscale ion conducting
40 channels that are periodically distributed among mechanically
41 rigid but ion insulating domains. Morphologies commonly
42 formed by BCEs include gyroid networks,¹² lamellae,¹³ and
43 hexagonally packed cylinders,¹⁴ ostensibly offering transport in
44 three, two, and one dimensions, respectively.

45 Structure–property relationships in BCEs are challenging to
46 derive because the periodic domain structure of BCEs formed
47 through self-assembly are well-ordered only locally at the
48 submicron scale but transport properties are typically
49 measured over macroscopic dimensions, on the scale of tens
50 to thousands of microns. At this device scale, the materials can

be described as consisting of multiple grains. The implications
51 of this structure are that, regardless of the local BCE
52 morphology, the materials have the potential to conduct in
53 three dimensions, the conduction pathways are likely to be
54 tortuous, and mechanisms of transport across grain boundaries
55 and defects must be considered. Effective medium theory
56 (EMT)¹⁵ is a methodology to characterize the dependence of
57 ion transport on morphology and is written in its simplest form
58 as
59

$$\sigma_{\text{BCE}} = f\phi_{\text{COND}}\sigma_{\text{HOMO}} \quad (1)$$

where σ_{BCE} is the conductivity of the BCE, σ_{HOMO} is the
61 conductivity of the homopolymer that is chemically identical
62 to the conducting block of the BCE, ϕ_{COND} is the volume
63 fraction of the conducting block, and f is a tortuosity factor.
64 The anticipated value of f for each grain in a BCP morphology
65 is uncomplicated: f equals one for gyroids and for sphere-
66 forming BCPs with majority phase conducting in all directions,
67

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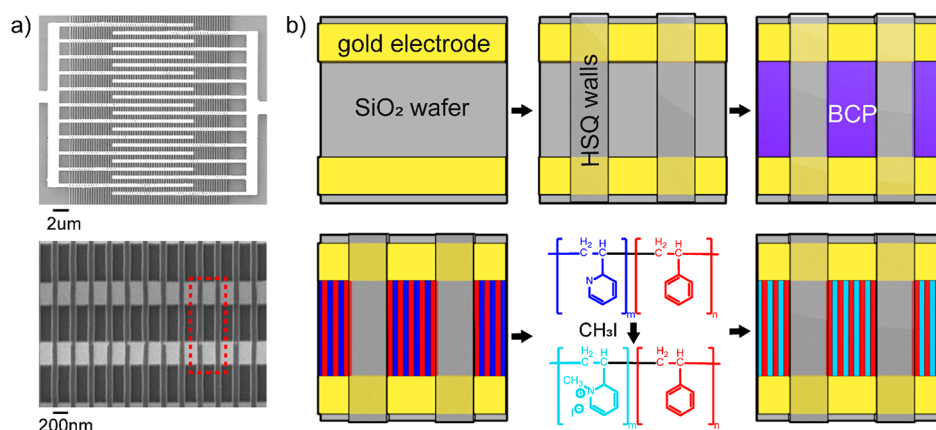


Figure 1. Schematic and results showing the fabrication and assembly processes for the graphoepitaxy interdigitated electrodes and the BCE. (a) SEM micrographs of the interdigitated electrodes with the gold electrodes appearing as the bright horizontal bars and the HSQ guiding topography as vertical stripes that form 200 nm by 1 μm trenches (single trench highlighted by a red box). (b) Fabrication schematic where the device is fabricated on a 1 μm thick SiO_2 substrate (top to bottom, left to right).

68 while f equals one for lamellae and cylinders in the directions
 69 parallel to the domains, and zero in the transverse directions.
 70 Theoretical values of f have been determined by Sax and
 71 Ottino¹⁵ for multigrained BCP films assuming no impediments
 72 to transport across defects and grain boundaries. They
 73 determined transport to be isotropic in the bulk, and f to be
 74 1 for bicontinuous morphologies such as gyroids, 1 for sphere-
 75 forming BCES where the majority phase is ion conducting, 0.33
 76 for cylinder-forming BCEs where the minority is ion
 77 conducting, and 0.66 for lamellae forming BCE, of primary
 78 interest in this work. Hallinan and Balsara¹⁶ have reviewed the
 79 conductivities of many different bulk and multigrain BCE
 80 systems with varying morphologies and tabulated or calculated
 81 the values of f . In the review and cited literature, the values of f
 82 reported for lamellae systems range from as low as 0.01 to
 83 within error of the theoretical value of 0.66. The majority of
 84 the reported material systems exhibited conductivities of the
 85 BCE that were not consistent with an EMT description. These
 86 included high molecular weight, lamella-forming BCPs such as
 87 polystyrene-*block*-poly(ethylene oxide) (PS-*b*-PEO) that have f
 88 values as low as 0.015,¹⁷ and lamellae forming BCEs that were
 89 aligned using external fields in an attempt to mitigate the effect
 90 of tortuosity described above that have f values below 0.1.¹⁸ In
 91 the few studies where the reported values of f were within an
 92 order of magnitude of the values predicted for multigrained
 93 samples, (1) the materials' systems were either lamellae
 94 forming BCPs with small grain sizes at the scale of the lamellar
 95 period itself, such as PS-*b*-PEO that reach an f value of 0.2^{19,20}
 96 or (2) fully microphase-separated, lamellae-forming BCPs with
 97 high volume fractions of low molecular weight ionic liquids
 98 (ILs) with f values approaching the theoretical value of 0.66.²¹
 99 As noted by many researchers, the information required to
 100 build a unifying, fundamental understanding of transport in
 101 BCE systems is a measurement of the structure-conductivity
 102 relationship under conditions in which the structure of the
 103 material is known quantitatively, especially as it relates to the
 104 role of transport across defects and grain boundaries. However,
 105 characterization of the structure at the scale of individual
 106 domains or conduction pathways, on the scale of 10–20 nm,
 107 throughout the entire volume at the device scale, for example, a
 108 membrane of 100 μm in thickness, is difficult or
 109 impossible.^{22–24}

Here we report the measurement of structure–electro-
 chemical property relationships in lamellae-forming BCEs
 using thin films and interdigitated electrodes. The use of thin
 films enables quantitative structural characterization, and the
 use of interdigitated electrodes results in measurements with
 high signal-to-noise ratios in electrochemical impedance
 spectroscopy. Fabrication of connected, partially connected,
 and unconnected morphologies between electrodes is achieved
 by rudimentary implementation of the techniques of directed
 self-assembly, and these structural motifs are analogous to
 grain boundary and defect structures found in the bulk.
 Conductivity is found to be directly proportional to the
 number and length of domains of the BCE that are connected
 from one electrode to the other. Any conducting domain
 within the film with even a single impeding defect (e.g., a
 dislocation) does not contribute to the conductivity and
 increases the dielectric parameter of the material. Films with
 no connecting pathways exhibit conductivities more than 4
 orders of magnitude lower and a dielectric parameter that is an
 order of magnitude higher than the connected film. These
 results signify that defects and grain boundaries play a central
 role in determining the electrochemical properties of self-
 assembling nanostructured electrolytes and are key parameters
 to understand and control in the design and processing of
 these materials.

The schematic for the fabrication of devices is shown in
 Figure 1. Gold interdigitated electrodes (IDEs) were fabricated
 on top of a silicon wafer with a 1 μm thick thermally grown
 oxide. Ninety nanometers of thick gold with a 10 nm Ti
 adhesion layer were deposited and patterned using ebeam
 lithography and liftoff techniques. The resulting IDE features 1
 μm wide electrode teeth that overlap counter electrodes by 20
 μm with a 1 μm separation distance. The teeth are arranged in
 an alternating sequence with each electrode going to one of the
 large contact pads for a total of 40 electrode teeth per pole.
 Following the fabrication of the IDE, 80 nm thick hydrogen
 silsesquioxane (HSQ) resist was cast on top of the IDE and
 patterned using electron beam (ebeam) lithography. The
 resulting HSQ structure formed rectangular grating structures
 perpendicular to the electrode axis consisting of 200 nm
 trenches on a 400 nm pitch as shown in Figure 1a. The HSQ
 grating and the gold electrodes formed elevated walls creating
 200 nm by 1 μm isolating trenches where the polymer could be

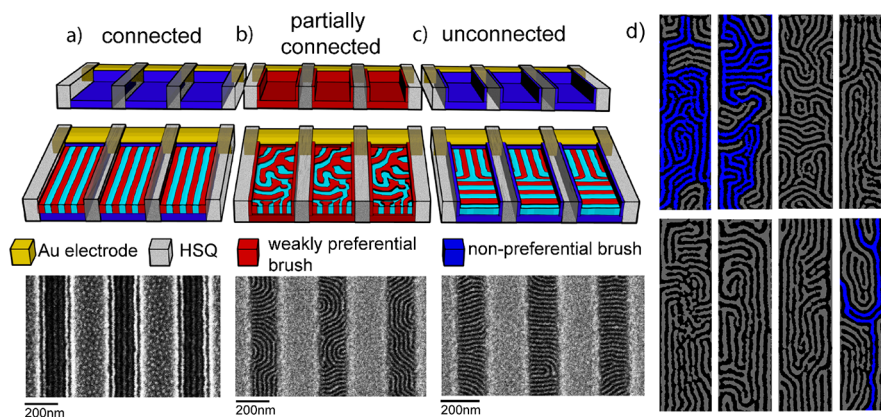


Figure 2. Orientation of the PS-*b*-P2VP domains relative to the HSQ guiding stripes and the electrodes that form the individual trenches. Schematic and SEM micrograph of (a) connected structure (b) partially connected, (c) unconnected orientation. (d) Partially connected morphology SEM micrographs after image flattening and path identification where disconnected paths are labeled gray and the connected domains are labeled blue.

153 confined and manipulated into different morphologies.
 154 Precisely 3950 identical trenches were fabricated on each
 155 IDE for polymer confinement.

156 The substrate, HSQ features, and electrodes were modified
 157 with polymer brushes at different stages during the fabrication
 158 process to induce the formation of three distinct BCE
 159 structures. Next, a film of lamellar-forming polystyrene-*block*-
 160 poly(2-vinylpyridine) (PS-*b*-P2VP) was spin coated onto the
 161 IDEs, solvent annealed in acetone, and dried such that all the
 162 polymer in the device area was confined in the trenches formed
 163 by the gold and the HSQ walls. The phase separated BCP film
 164 was then functionalized to become a BCE by exposing the film
 165 to methyl iodide (MeI) vapor for 24 h. As reported previously
 166 under these conditions, approximately 50% of the P2VP repeat
 167 units were functionalized with a fixed quaternary ammonium
 168 cation (NMP⁺) and a free iodide anion (I⁻). The BCE film was
 169 subsequently equilibrated in an environment with 95% relative
 170 humidity (95% RH) at 25 °C for 6 h. The volume fraction of
 171 the P2VP/NMP⁺ I⁻ block increased from 50% to 58% after
 172 functionalization and hydration (see [Supporting Informa-](#)
 173 [tion](#)).²⁵ The absorbed water dissociates the iodide from the
 174 cation and plasticizes the P2VP/NMP⁺I⁻ domain such that the
 175 T_g of the conducting blocks are below room temperature. The
 176 samples were characterized using alternating current (ac)
 177 electrochemical impedance spectroscopy (EIS) with a range of
 178 frequencies from 1 MHz to 0.1 Hz with a perturbation voltage
 179 of 10 mV.

180 The morphology of the BCE films after deposition,
 181 annealing, and functionalization on the device depended on
 182 the engineered boundary conditions of the trenches within the
 183 IDEs. The SiO₂ substrate, the HSQ side walls, and the gold
 184 surfaces²⁶ without chemical modification are all preferentially
 185 wet by one block of the BCP. PS preferentially wetted the
 186 HSQ and the gold surfaces, whereas P2VP preferentially
 187 wetted the bare SiO₂ substrate. The substrate, HSQ walls, and
 188 the gold surfaces were chemically modified at different stages
 189 of the fabrication process to be nonpreferential in wetting
 190 toward the BCP by grafting or physisorbing hydroxyl-
 191 terminated poly(styrene-*rand*-2-vinylpyridine) (P(S-*r*-2VP)-
 192 OH) brushes.²⁷ Under conditions in which a P(S-*r*-2VP)-
 193 OH brush was deposited onto the substrate prior to the
 194 fabrication of the HSQ guiding lines, and the monomeric mole
 195 fraction of PS in the brush was 0.685, graphoepitaxial assembly

of the BCP occurred in the trenches with preferential wetting
 of the HSQ sidewalls, neutral (SiO₂-brush) bottom surfaces,
 and neutral (gold) sidewalls. With these boundary conditions,
 the BCP domains assembled perpendicular to the substrate
 and uniformly parallel to the HSQ walls with each domain
 forming a straight and continuous pathway between pairs of
 electrodes ([Figure 2a](#)). In this morphology, seven natural
 periodicities of PS-*b*-P2VP/NMP⁺ I⁻ were assembled parallel
 to the HSQ walls. In our previous work,²⁵ we extracted the
 periodicity of the BCP to be 28 nm. Therefore, in an
 unconfined film the seven periods in parallel would result in a
 film width of 196 nm, which is consistent with the separation
 distance between the two HSQ walls. This morphology will be
 referred to as the “connected” structure. Second, samples were
 fabricated after depositing a different P(S-*r*-2VP)-OH brush
 that was weakly preferential to P2VP (monomeric mole
 fraction of PS in the brush equal to 0.48) on all surfaces of the
 devices after the HSQ fabrication. Under these conditions, the
 BCP domains assembled perpendicular to the substrate but in
 a fingerprint pattern in the plane of the film ([Figure 2b](#)). This
 morphology will be referred to as the “partially connected”
 structure. Finally, when the neutral P(S-*r*-2VP)-OH brush was
 deposited after the HSQ fabrication, all surfaces of the
 confining trenches were nonpreferential in wetting toward the
 copolymer. Under these boundary conditions, the BCP
 domains assembled perpendicular to the substrate, perpendicular
 to the gold electrodes, and perpendicular to the HSQ
 walls. Because of the aspect ratio, there was a section in the
 middle of the trenches over which the lamellae spanned from
 one HSQ wall to the other with no domains forming pathways
 between electrodes (see [Figure 2c](#)). This morphology will be
 referred to as the “unconnected” structure. Representative
 SEM images are shown in [Figure 2d](#) and connected domains
 from one electrode (top to bottom) to another in the images
 are identified and labeled in blue.

Two additional types of samples were prepared to compare
 and contrast with the results of the controlled morphologies.
 For the first sample, a P2VP homopolymer of comparable
 molecular weight to the P2VP block of the BCP ($M_n = 22\,000$
 g mol^{-1}) was deposited on the IDE with the HSQ features,
 annealed, and functionalized under identical protocols to the
 BCE. This sample will be referred as the “homopolymer”
 sample. For the second sample, the HSQ grating features were

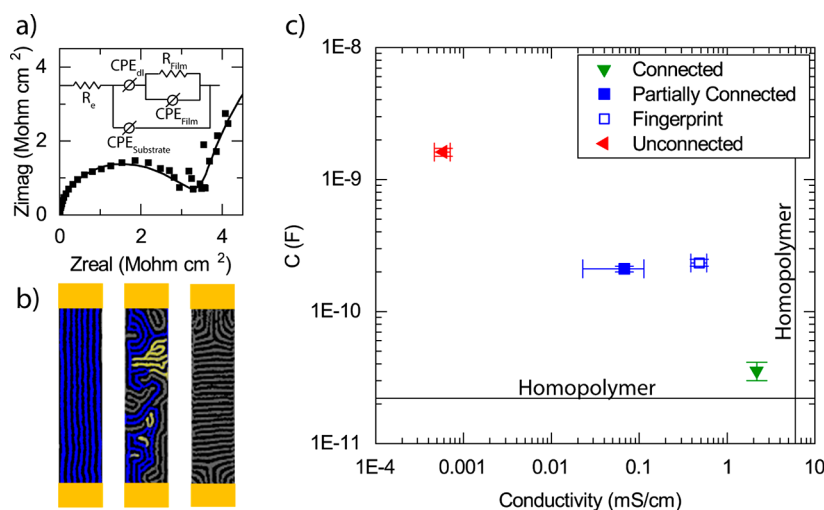


Figure 3. SEM and EIS results correlating the ion conduction pathways to electrochemical behavior. (a) Multivariable fit of EIS data for the connected structure using a custom equivalent circuit diagram to simulate the charge transport pathway. (b) Analyzed SEM micrographs of ion conduction pathways (percolated paths labeled in blue with nonparticipating sections in yellow) in segmented HSQ trenches showing (left to right) connected, partially connected (confined), and disconnected orientations. (c) Calculated C and conductivity for each structure orientation with performance limitations for the PS-*b*-P2VP/NMP⁺ I⁻ system (solid lines) calculated from the homopolymer impedance values.

not fabricated on top of the IDE. P(S-*r*-2VP)-OH brush was deposited over the entire surface to form a uniformly nonpreferential substrate. Then the BCP was deposited, annealed, and functionalized to form a morphology that will be referred to as the “fingerprint” structure.

An equivalent circuit model with the elements representing material and device properties to capture the essential physics of the system was used to derive the resistance and dielectric values related to the transport of ions in the polymer films from the EIS data. Recently Sharon et al.²⁸ reported on the conditions and system parameters for which the IDEs and circuit model yield quantitative material transport properties for ion conducting polymer films. The model is comprised only of circuit elements that have physical manifestations in the charge transport in the IDE configuration. In this study, the model consists of resistors (R) and constant phase elements (CPE) in the setup shown in Figure 3a: R_{film} and CPE_{film} capture the resistance and dielectric behavior of the polymeric material between the electrodes, respectively, CPE_{dl} models the ion depletion double-layer at the polymer–electrode interface, $\text{CPE}_{\text{SiO}_2}$ represents the dielectric behavior of the SiO_2 substrate, and $R_{\text{electrode}}$ models the electrode resistance. Conductivity (σ) of the polymer was calculated using from the value of R_{film} using the following equation

$$\sigma = \frac{d}{R_{\text{film}}Lt(N-1)} \quad (2)$$

where N is the number of electrode teeth in the interdigitated array, t is the film thickness of the polymer in the trench, d is the separation distance between the edges of electrodes, and L is the length of overlap between adjacent electrodes for the polymer not including the areas occupied by the HSQ. Capacitance (C) is derived from the CPE_{film} in the equivalent circuit model by using the following equation

$$C = \frac{(R_{\text{film}}Q^{-1})^{1/a}}{R_{\text{film}}} \quad (3)$$

where Q and a are the fitting parameters of the CPE_{film} . The unit of the Q is $\text{S}^* \cdot \text{s}^a$. Note that CPEs are used instead of pure

capacitor elements in the circuit model to improve the fit to the data. However, all values of a from modeling the EIS data were above 0.8, indicating that CPE_{film} was behaving as, and can be interpreted as, a near pure capacitor element. Figure 3a provides representative electrochemical data (scatter plot) in the form of a Nyquist plot and the fit (solid line) for the BCE with the partially connected structure. The values used for the calculation of the σ and C are tabulated in the Supporting Information.

The electrochemical behavior of BCEs in the EIS experiments showed marked differences as a function of structure. A log–log plot of the values of σ and C derived from the EIS data for the connected, disconnected, and partially connected BCE structures is shown in Figure 3c. The solid lines also shown in Figure 3c are the $\sigma_{\text{homopolymer}}$ and $C_{\text{homopolymer}}$ values for the homopolymer that correspond to the electrochemically active block of the BCEs. Several features in the log–log plot stand out. First, the σ of the homopolymer and the connected structure are relatively high, ~ 2 to 6 mS/cm, and C of the homopolymer and the connected structure are relatively low, $\sim 3 \times 10^{-11}$ F. For comparison, hydrated Nafion 117 has a conductivity of 79 mS/cm and C of 9×10^{-10} F when conditioned at 25 °C and 95% RH.²⁹ Second, σ_{BCE} of the unconnected structure was 4 orders of magnitude smaller than σ_{BCE} of the connected structure or σ_{HOMO} , so it was negligible in comparison. The fact that there is no conductivity when there are no domains connecting the electrodes highlights the integrity of the samples and experimental procedures. There are no unanticipated or unwanted pathways for conduction in the samples, such as through a layer of swollen polymer on the surface, through a layer of condensation of the surface, through the brush materials, or through the underlying substrate. Third, C of the unconnected structure was a factor of 50 higher than the connected structure, indicating the presence of trapped charge. Fourth, the values of the σ_{BCE} and the C of the partially connected structure were intermediate between the connected and unconnected structures, suggesting that σ_{BCE} is proportional to the number of connected domains, and that C was proportional to the number of isolated domains, dead ends, or

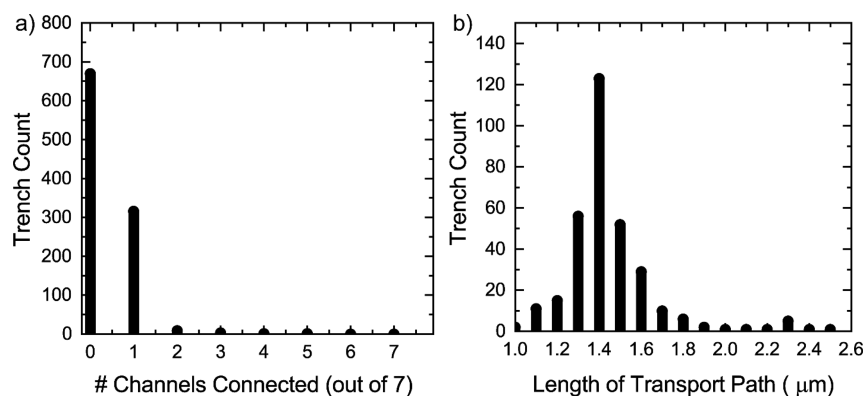


Figure 4. Extracted structure data of the partially connected morphology using visual analysis software showing (a) the total number of connected conduction paths where the total number of conduction channels is at a bottleneck, and (b) the total number of trenches as a function of the length of the conduction pathway.

ion trapping defects. Fifth, the σ_{BCE} value of the fingerprint structure was a factor of 7 larger than the partially connected film while the C stayed about the same. This suggests that there are more conduction pathways in the fingerprint structure, but there is still a significant volume of “dead” paths. The electrochemical structure–transport properties of the BCE films are discussed in quantitative fashion below.

It is important to note that the absolute conductivity and C values of the connected morphology are close but not equal to the values of the homopolymer. The ability to probe a fully connected structure allows us to decouple and independently characterize the parameters f and ϕ_{COND} in the EMT (eq 1). Using experimental values of σ_{HOMO} and σ_{BCE} equal to 6 and 2.2 mS/cm (see Supplemental Table 1), and $f = 1$ in eq 1, ϕ_{COND} of the connected structure is calculated to be 0.37, a value substantially lower than the estimated volume fraction of the hydrated P2VP/NMP⁺ I[−] in the BCE of 0.58. Unlike the P2VP/NMP⁺ I[−] homopolymer, the PS-*b*-P2VP/NMP⁺ I[−] BCE contains domain interfaces with PS over which the P2VP/NMP⁺ I[−] and PS are mixed over the length scale of a few nanometers.³⁰ P2VP/NMP⁺ I[−] in the interfacial regions does not likely contribute to conductivity due to the presence of even small concentrations of PS. The mechanisms by which PS may reduce the conductivity when mixed with P2VP/NMP⁺ I[−] include the following: (1) a reduction of local charge carrier concentration due to the hydrophobic PS lowering the local hydration levels, (2) a reduction in ionic mobility due to slower segmental dynamics of P2VP/NMP⁺ I[−] near the interface with glassy PS, or (3) a reduction in ion hopping probability due to the dilution of active sites by the PS. The mechanisms for reduced conductivity near the interface of conducting rubbery and nonconducting glassy domains have been reported previously for the PS-*b*-PEO system.^{31,32} If we assume that all of the P2VP/NMP⁺ I[−] that does not contribute to conductivity resides at domain interfaces, then the width of those interfacial regimes is approximately 3 nm (see Supporting Information on calculating inactive interfacial width from conductivity), a value consistent with the width of the interface in block copolymer theory calculated using the Flory–Huggins interaction parameter χ .^{30,33,34} Additionally, the value of C derived from the EIS data for the connected film (2.83 nF) is close to that of the homopolymer (2.5 nF) but slightly higher. We attribute this increased C to impeded transport of ions near domain interfaces where the P2VP/NMP⁺ I[−] is nonconductive.

A comparison between defect-free connected and defect containing partially connected structures allows for analysis of the role of defects and grain boundaries on BCE transport properties. Because the state of the hydrated P2VP/NMP⁺ I[−] domains of fully microphase-separated BCE films are all equivalent at the same temperature and relative humidity, quantitative comparisons of conductivities and structure are possible between all of our samples with fully formed lamellae morphologies. σ_{BCE} of the BCE with a connected structure was 31-fold higher than σ_{BCE} of the BCE with a confined, partially connected morphology (2.2 versus 0.07 mS/cm). The lower σ_{BCE} observed in the partially connected BCE films could be fully accounted for by taking into account two structural differences between the samples: (1) the number of P2VP/NMP⁺ I[−] domains that are connected from one electrode to the other, and (2) the tortuosity (distance traveled between electrodes) of the connected domains.

The quantitative analysis was made using the equation

$$\sigma_{\text{pc,eff}} = \frac{m_{\text{pc}}}{m_{\text{c}}} \frac{l_{\text{c}}}{l_{\text{pc}}} \sigma_{\text{c}} \quad (4)$$

where $\sigma_{\text{pc,eff}}$ is the estimated effective conductivity of the partially connected morphology based on the assumptions above, σ_{c} is the conductivity of the connected morphology, m_{pc} is the total number of connected paths for the partially connected morphology, m_{c} is the total number of connected paths for the connected morphology, l_{pc} is the average length of the conduction path for the partially connected morphology, and l_{c} is the average length of the conduction path for the connected morphology.

The values of m_{pc} , m_{c} , l_{pc} , and l_{c} were determined by inspecting and performing image analysis on scanning electron micrographs of 1000 trenches in selected samples and counting and averaging the total number of connected pathways and the increase in the transport path length due to increased tortuosity. The statistics for the analysis are recorded in Figure 4. We determined m_{c} to be 27 650 connected paths by counting a total of 7 connected paths per trench and multiplying by 3950, which is the total number of trenches. Next, m_{pc} was determined by identifying and counting the connected paths in 1000 randomly selected trenches. Image analysis showed only 300 of 1000 trenches had connected pathways, and the vast majority of the 300 trenches contained only a single connected path. The trenches with zero connected paths were similar in morphology but every 400

401 P2VP/NMP⁺ I⁻ channel was blocked by at least one PS
 402 domain barrier. The analysis of one trench shown in Figure 3d
 403 illustrates by example how we determined the number of
 404 pathways per trench if a connection existed. The number of
 405 connected pathways per trench was determined at the
 406 bottleneck where the ion transport would be gated. For
 407 example, the partially connected BCE structure analyzed in
 408 Figure 3d had seven separate ion conduction paths that make
 409 contact with the electrode. However, at the cross section with
 410 the smallest number of connected channels (i.e., the middle of
 411 the film), only a single channel is highlighted in blue.
 412 Therefore, this trench was determined to contain only one
 413 connected path out of seven. Additional examples of partially
 414 connected morphologies are shown in Figure 2d and the
 415 compiled count of trenches with specific number of connected
 416 domains is shown in Figure 4a. The m_{pc} value of 1185 was
 417 calculated by multiplying the fraction of connected trenches
 418 (300/1000) by the total number of trenches (3950) where
 419 each trench contained only one connected path. The
 420 conduction pathlengths l_{pc} and l_c were determined by tracing
 421 the shortest connected path from one electrode to the other on
 422 the SEM image and determining the length of the traced line
 423 using ImageJ graphic analysis software. The conduction
 424 pathways identified in the partially connected structure were
 425 more tortuous in comparison to the connected structure. The
 426 distribution of trenches with specific lengths of connected
 427 paths are shown in Figure 4b. Because of the higher tortuosity,
 428 the connected pathways in the partially connected morphology
 429 were measured to have an l_{pc} of 1.4 μm . l_c of the connected
 430 morphology is simply the separation distance of the electrodes
 431 in the IDE, namely 1 μm . Using the values of m_{pc} , m_c , l_{pc} and l_c
 432 in eq 4 and testing the hypothesis that σ is proportional to the
 433 number of paths and inversely proportional to the path length,
 434 we estimate σ_{pc} to be 0.067 mS/cm, a value that compares very
 435 favorably with the experimentally determined value of 0.07 \pm
 436 0.05 mS/cm. The values are tabulated in Table 1. Using eq 4,

Table 1. Structure Parameters m and l Extracted from Structure Analysis of SEM Micrographs and the Calculated Conductivities Using Equation 4, m_c , l_c , and σ_c

	units	connected	partially connected	unconnected
m		27650	1185	0
l	μm	1	1.4	
σ	mS/cm	2.2	0.067	0

437 the unconnected morphology would have an m value of 0,
 438 resulting in a calculated conductivity of zero. Note:
 439 conductance was used to compare the two morphologies
 440 instead of resistance because conductance scales with the total
 441 number of connected domains. The derivation of eq 4 is
 442 explained in the Supporting Information.

443 The C value from the equivalent circuit model can provide
 444 valuable structural information that is complementary to that
 445 derived from the conductivity analysis. Whereas the connected
 446 structure has very small differences in C from that of the
 447 homopolymer, the partially connected morphology has a C
 448 value that is higher by an order of magnitude. This suggests
 449 that substantial charge accumulation occurs in the defective
 450 structures of the partially connected films. Defect structures
 451 that exist in the partially connected domains include (1) dead
 452 ends of connected ion conduction paths (colorized yellow in
 453 Figure 3b) and (2) disconnected ion conduction pathways

(colorized gray in Figure 3b). Furthermore, C value for the
 454 unconnected morphology with the highest number of
 455 disconnected domains was higher by an order of magnitude
 456 compared to the partially connected morphology. From this
 457 comparison, we can speculate that values of C derived from the
 458 EIS data are a measure of the relative volume fractions of
 459 material that are “dead” to transport due to defects and grain
 460 boundaries. In this sense, reporting the C value and looking for
 461 order of magnitude differences between homopolymer and
 462 nanostructured samples may be a useful tool to estimate the
 463 relative magnitude that structure and processing is playing in
 464 bulk measurements for which structure cannot be determined
 465 independently.

To further explore the properties of defect structures and to
 467 take a small step from the confined two-dimensional structures
 468 presented above toward more three-dimensional structures, (or
 469 at least unconfined two-dimensional structures), we also
 470 investigated BCE films with fingerprint lamella patterns on
 471 the IDEs without the confining HSQ guiding topography. The
 472 σ_{BCE} of the fingerprint structure was found to be a factor of 7
 473 higher than the σ_{BCE} of the partially connected structure (0.5
 474 versus 0.07 mS/cm), whereas C remained almost constant.
 475 The 7-fold increase in σ_{BCE} suggests that the fingerprint
 476 structure without the guiding topography provided more
 477 connected pathways between the electrodes, perhaps with
 478 longer more tortuous routes than were possible when confined
 479 by the HSQ guides. The σ_{BCE} of the fingerprint structure was
 480 also only an order of magnitude lower than σ_{HOMO} (0.5 versus
 481 6 mS/cm), and this difference is expected to decrease further
 482 upon moving to a fully three-dimensional domain structure for
 483 which there are additional pathways to circumvent defects. The
 484 fact that the C value was equivalent between the two samples,
 485 and was much higher than C of the connected structure or
 486 homopolymer, suggests that despite more pathways there is
 487 still a significant fraction of the fingerprint films that did not
 488 contribute to the σ_{BCE} . An analogous observation has been
 489 reported by Diederichsen et al.³⁵ who studied electron
 490 transport in fingerprint BCP morphology templated gold
 491 nanowires. A discrete fraction of disconnected domains can
 492 reduce the conductivity by increasing tortuosity of connected
 493 paths and limiting the conductive volume.

In conclusion, the use of thin films and IDEs allowed for
 495 quantitative determination of structure property relationships
 496 in BCEs. Defects and grain boundaries often create dead ends
 497 for pathways of the conducting component with the net result
 498 of reduced conductivity as substantial volume fractions of
 499 material are no longer active in transport processes. The results
 500 of this study complement the past literature and improve our
 501 understanding of the use, potential caveats, and shortcomings
 502 of eq 1 and EMT to analyze transport in these materials.
 503 Whereas f is usually considered to account for structural
 504 information and has been used as a basis for comparison of
 505 differences in structure, in practice it is often better described
 506 as an empirical efficiency factor. Lumped into f is tortuosity,
 507 the impact of defects and grain boundaries, an effective volume
 508 fraction of conducting material, and perhaps even the
 509 possibility that the pure conducting material in the nano-
 510 structured confinement does not have the same conductivity of
 511 the pure conducting material in the bulk. Of these factors, only
 512 defects and grain boundaries can potentially reduce σ_{BCE} by an
 513 order of magnitude or more compared to the σ_{HOMO} ; the
 514 reduction in conductivity due to tortuosity or an effective
 515 ϕ_{COND} is likely maximized at a factor of two or three. Finally, 516

517 there is opportunity to combine thin film experiments and
518 analysis as described here with bulk measurements on the same
519 material; the complementary information may yield the
520 fundamental understanding necessary for the design of
521 materials and strategies for processing to realize selective and
522 highly conducting membranes for electrochemical applications.

523 **Materials.** The block copolymer PS-*b*-P2VP (M_n of 25 kg
524 mol⁻¹ PS, 22 kg mol⁻¹ P2VP) was received from Polymer
525 Source and used as is. The monohydroxy terminated random
526 copolymer brush (P(*S-r*-2VP)-OH) was synthesized as
527 described in the Supporting Information. The neutral
528 preference surface was formed using the P(*S-r*-2VP)-OH
529 brush with 69% of the repeat units comprising of PS while the
530 weakly preferential surface was formed using the P(*S-r*-2VP)-
531 OH with 48% of the repeat units comprising of PS. All other
532 chemicals (methyl iodide, toluene, *N,N*-dimethylformamide
533 (DMF), methyl isobutyl ketone (MIBK), tetrahydrofuran
534 (THF), acetone, and 2-propanol (IPA)) were received from
535 Sigma-Aldrich or Fisher Scientific and used without further
536 purification. The gold interdigitated electrodes with HSQ
537 guiding stripes were fabricated on semiconducting polished
538 silicon wafers (1 μm thermally grown oxide layer) obtained
539 from WRS materials. PMMA 950 k MW and MMA 6.5
540 photoresists were obtained from MicroChem Corporation and
541 used as is for photolithography fabrication of the gold
542 electrode layer. The HSQ photoresist FOX22 used for the
543 guiding stripe layer was obtained from Du Pont Chemicals and
544 diluted to 1:2 (v/v FOX22/MIBK) prior to use to control the
545 thickness of the final film.

546 **Fabrication of Interdigitated Electrodes with Nano-
547 scale Trenches.** Silicon wafers with a 1 μm thick, thermally
548 grown oxide was cleaned with piranha solution (70:30 v/v
549 mixture of concentrated sulfuric acid and 35 wt % hydrogen
550 peroxide) for 30 min at 130 °C. The wafer was dehydrated on
551 a hot plate at 80 °C for 15 min prior to being spun coat with a
552 bilayer photoresist of MMA 6.5 (120 nm) and PMMA 950A
553 (140 nm). The device pattern was written using the NFD
554 JEOL JBX-9300FS electron beam lithography system with an
555 acceleration voltage of 100 kV and a dose of 1200 μC/cm²,
556 and was developed with 1:3 v/v MIBK/IPA solution for 30 s,
557 rinsed in IPA, and blown dry with N₂. The sample was then
558 subject to 8 s of O₂ plasma to descum the lithographic features
559 prior to evaporation of 10 nm of a titanium adhesion layer
560 followed by a 90 nm gold layer using the AJA ATC-Orion
561 electron beam evaporation chamber. The wafer was soaked in
562 *N*-methyl-2-pyrrolidone at 80 °C for 15 min under subtle
563 agitation for liftoff. The HSQ trench pattern was written using
564 the NFD JEOL JBX-9300FS electron beam lithography system
565 with an acceleration voltage of 100 kV and a dose of 1400 μC/
566 cm² and was developed with CD26 for 3 min, rinsed in DI
567 water, and blown dry with N₂. Alignment marks were used to
568 orient the topographic features in HSQ relative to the
569 interdigitated electrodes.

570 **Control of Morphology in the Nanoscale Trenches.**
571 The substrate, HSQ features, and the gold electrodes were
572 grafted or physisorbed with hydroxyl-terminated (P(*S-r*-
573 2VP)-OH) brushes. The brushes were deposited by spin
574 coating a film of P(*S-r*-2VP)-OH (1 wt % dissolved in
575 toluene), annealing at 200 °C for 2 h, rinsing away the excess
576 by soaking in a toluene bath at 60 °C with periodic stirring by
577 hand, rinsed in IPA, then blown dry with N₂.²⁷

578 **Characterization.** Top-down SEM images of the self-
579 assembled BCE films were taken with the Carl Zeiss–Merlin

field emission scanning electron microscope. The acceleration 580
voltage was 1.0 kV with a working distance of 3 to 4 mm using 581
an in-lens detector. One nanometer of Pt/Pd was sputtered 582
onto the surface of the device using the Cressington 108 Auto 583
Sputter Coater to reduce electron beam charging and improve 584
the image quality. Image processing of the lamellar structure 585
was done via a visual Python analysis code explained in the 586
Supporting Information and Figure S3. The electrochemical 587
properties of the samples were probed using the Gamry 588
reference 600 potentiostat ac EIS. EIS measurements were 589
made from 1 MHz to 1 Hz^{36–38} by connecting the IDEs to 590
larger two-probe contact pads wired to the potentiostat/ 591
galvanostat. The measurements were made in a chamber with 592
controlled temperature (25 °C) and relative humidity (95% 593
RH) after an equilibration period of at least 24 h. Humidity- 594
controlled testing at 25 °C and 95% RH eliminates undesired 595
condensation of water at the interfaces but hydrates the P2VP/ 596
NMP⁺ I⁻) domains, enabling iodide transport at a common 597
device operating condition. 598

■ ASSOCIATED CONTENT 599

📄 Supporting Information 600

The Supporting Information is available free of charge on the 601
ACS Publications website at DOI: 10.1021/acs.nano- 602
lett.9b01758. 603

IDE device design, the schematics of the solvent vapor 604
annealing chamber, RH and temperature controlled 605
electrochemical test setup, the quantified structure 606
parameter analysis, additional connected trench images, 607
raw electrochemical data, and extracted model fit values 608
for the structures, synthesis of the monohydroxy 609
terminated random copolymer brush (P(*S-r*-2VP)- 610
OH), hydrated thickness calculations, justification of 611
conductivity calculation for connected and partially 612
connected structures, and the interpretation of the C 613
data (PDF) 614

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Notes 623

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636 ■ ABBREVIATIONS

637 BCP, block copolymer; BCE, block copolymer electrolytes;
638 EMT, effective medium theory; SEM, scanning electron
639 microscopy; IDE, interdigitated electrodes; HSQ, hydrogen
640 silsesquioxane; RH, relative humidity; EIS, electrochemical
641 impedance spectroscopy; MeI, methyl iodide

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